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| FORM PTO-1449 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT | ATTY DOCKET NO. | SERIAL NO. |
| | SJO9-2000-0067US1 | 09/764,019 |
| | APPLICANT | |
| | Hsiao et al. | |
| | FILING DATE | GROUP |
| | January 16, 2001 | 2652 |

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Notice of References CitedApplication/Control No.
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Reexamination
HSIAO ET AL.Examiner
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2652

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Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.

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| | APPLICANT Hsiao et al. | |
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